

HSMW-C230

White Color Side-Mount ChipLED

Description

The Broadcom® HSMW-C230 is a side-emitting surface-mount chipLED. This chipLED comes in small package footprint of 1.0 mm × 0.55 mm. Its small form factor allows flexible board design, and the LED can be closely mounted, thus offering maximum miniaturization benefits to the user.

The low package height of 0.3 mm makes it an ideal solution for an application that has limited head room, such as wearables and small portable handheld devices.

By using efficient and high brightness InGaN LED materials, this product is capable of delivering high light output. It is compatible with industry-standard automatic machine placement and reflow soldering.

Features

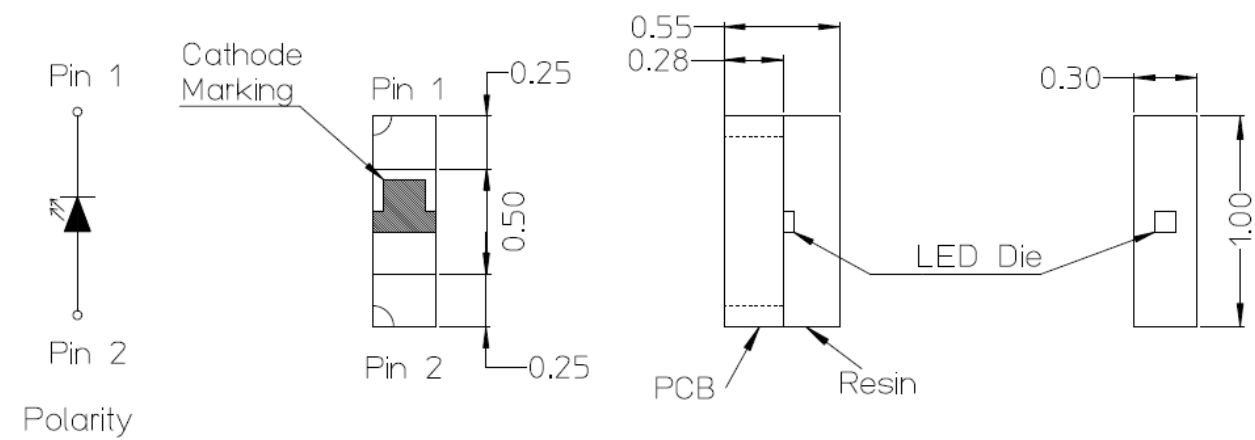
- LEDs with InGaN die
- Surface-mount device with 0.30-mm height
- Compatible with reflow soldering
- Tape in 8-mm carrier tape on a 7-in. diameter reel

Applications

- Backlighting
- Indicator

CAUTION! LEDs are class 1A ESD sensitive per ANSI/ESDA/JEDEC JS-001. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

Figure 1: Package Dimensions



NOTE:

- 1. All dimensions are in millimeters.
- 2. Tolerance ± 0.1 mm unless otherwise specified.
- 3. Encapsulant: clear epoxy

Absolute Maximum Value at $T_J = 25^{\circ}\text{C}$

Parameter	Rating	Units
DC Forward Current ^a	10	mA
Peak Forward Current ^b	40	mA
Power Dissipation	31	mW
LED Junction Temperature	95	$^{\circ}\text{C}$
Operating Temperature	-40 to +85	$^{\circ}\text{C}$
Storage Temperature	-40 to +85	$^{\circ}\text{C}$

a. Derate as shown in [Figure 11](#).
b. Duty factor = 10%, frequency = 1 kHz.

Optical/Electrical Characteristics at $T_J = 25^{\circ}\text{C}$, $I_F = 5\text{ mA}$

Parameter	Min.	Typ.	Max.	Units
Luminous Intensity, I_v^a	45.0	—	—	mcd
Viewing Angle, $2\theta_{1/2}^b$	—	175	—	degree
Forward Voltage, V_F	2.55	—	3.15	V
Reverse Current, I_R (at $V_R = 5\text{V}$) ^c	—	—	100	μA
Thermal Resistance, $R\theta_{J-S}$	—	320	—	$^{\circ}\text{C/W}$

- The luminous intensity is measured at the mechanical axis of the LED package. The actual peak of the spatial radiation pattern may not be aligned with the axis.
- Viewing angle is the off-axis angle where the luminous intensity is $\frac{1}{2}$ the peak intensity.
- Indicates the product final test condition. Long-term reverse bias is not recommended.

Bin Information

Intensity Bins (CAT)

Bin ID	Luminous Intensity (mcd)	
	Min.	Max.
P	45.0	71.5
Q	71.5	112.5
R	112.5	180.0
S	180.0	285.0
T	285.0	450.0
U	450.0	715.0
V	715.0	1125.0
W	1125.0	1800.0
X	1800.0	2850.0
Y	2850.0	4500.0

Tolerance $\pm 15\%$.

Forward Voltage Bins

Bin ID	Forward Voltage (V)	
	Min.	Max.
1	2.55	2.75
2	2.75	2.95
3	2.95	3.15

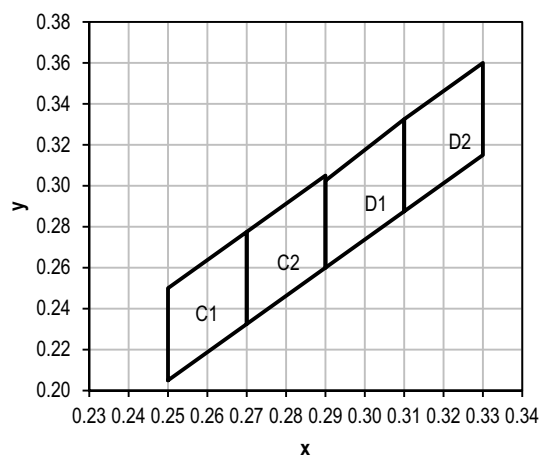
Tolerance $\pm 0.1V$.

Color Bins (BIN)

Bin ID	Chromaticity Coordinates	
	x	y
C1	0.2500	0.2050
	0.2500	0.2500
	0.2700	0.2775
	0.2700	0.2325
D1	0.2900	0.2600
	0.2900	0.3025
	0.3100	0.3325
	0.3100	0.2875
C2	0.2700	0.2325
	0.2700	0.2775
	0.2900	0.3050
	0.2900	0.2600
D2	0.3100	0.2875
	0.3100	0.3325
	0.3300	0.3600
	0.3300	0.3150

Tolerance ± 0.001 .

Figure 2: Chromaticity Coordinates Diagram



Example of bin information on reel and packaging label:

CAT: P $\rightarrow$ White = lv bin P

BIN: C1 $\rightarrow$ White = color bin C1

Figure 3: Intensity vs. Wavelength

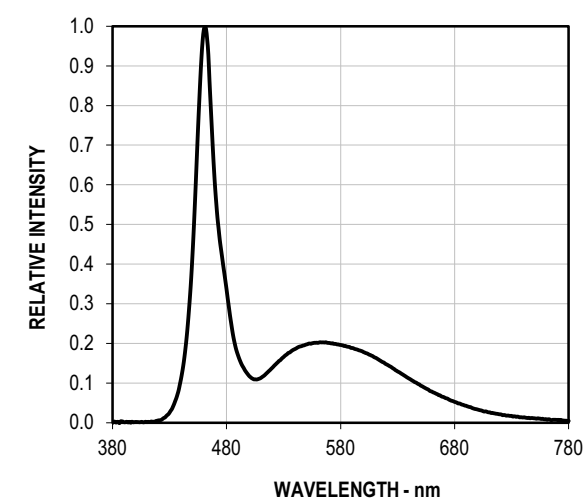


Figure 4: Forward Current vs. Forward Voltage

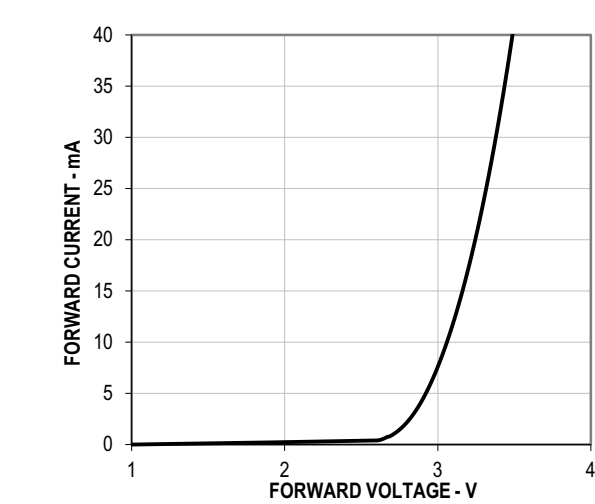


Figure 5: Intensity vs. Forward Current

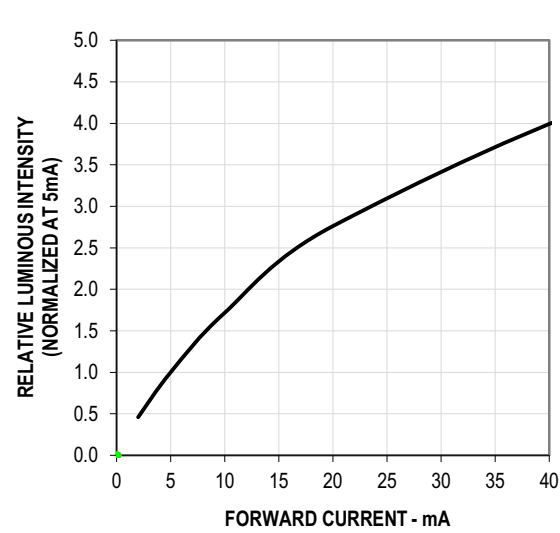


Figure 6: Intensity vs. Angle

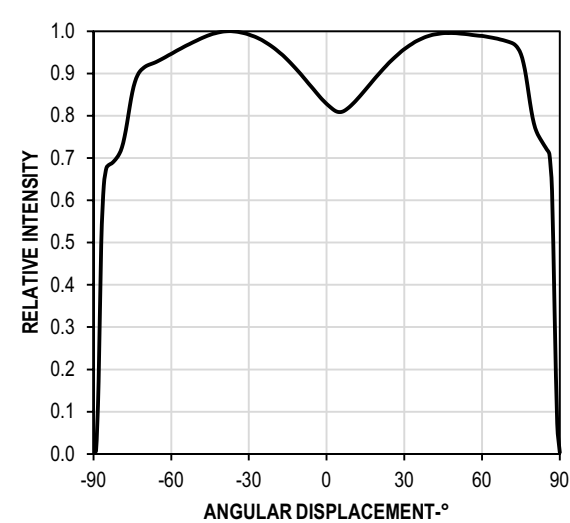


Figure 7: Wavelength vs. Forward Current

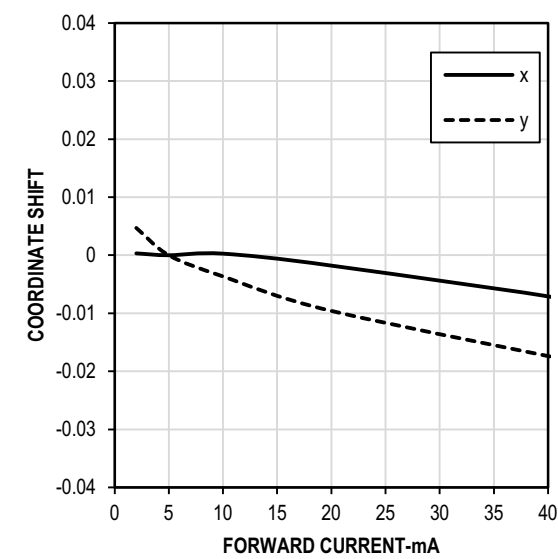


Figure 8: Intensity vs. Temperature

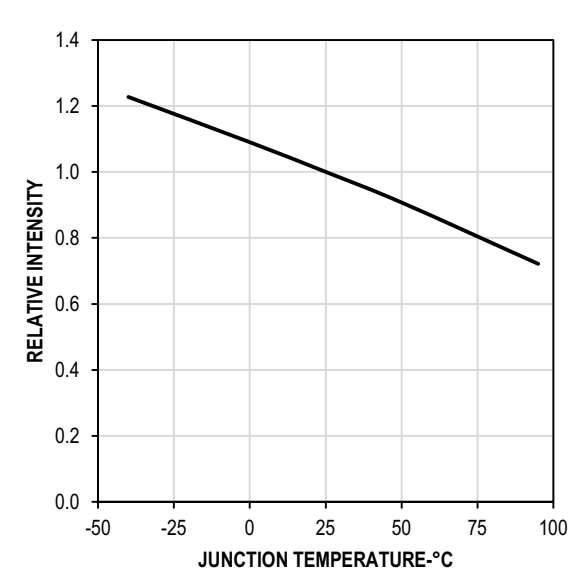


Figure 9: Wavelength vs. Temperature

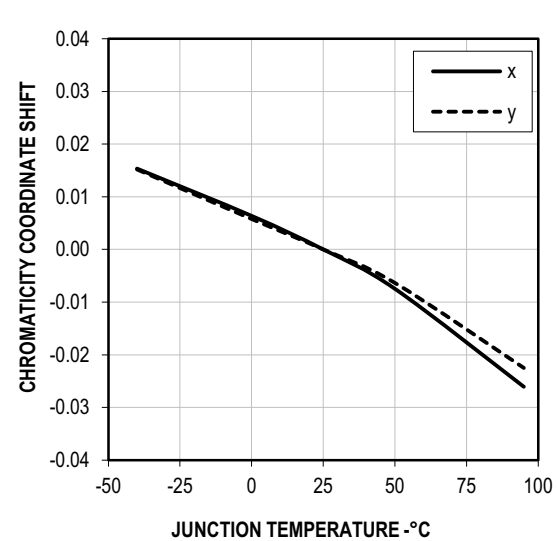


Figure 10: Forward Voltage vs. Temperature

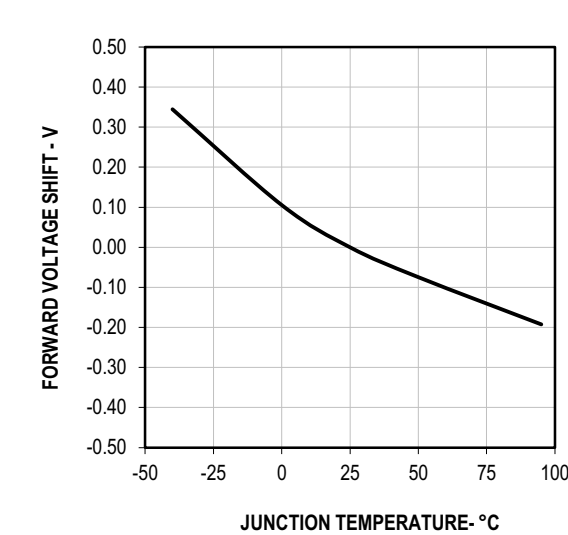


Figure 11: Forward Current vs. Temperature

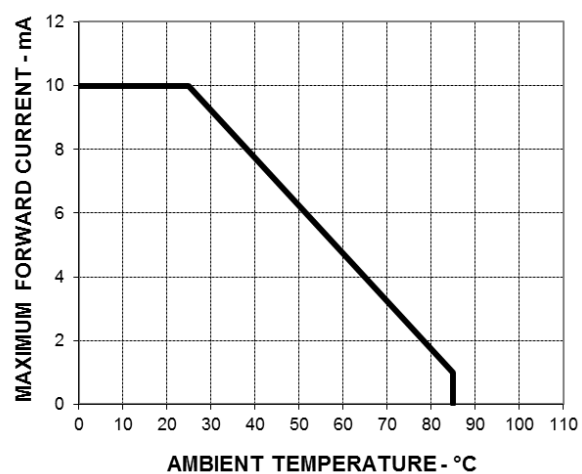


Figure 12: Recommended Solder Pad (Units: mm)

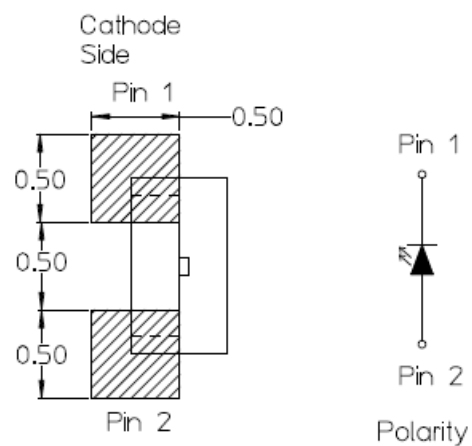
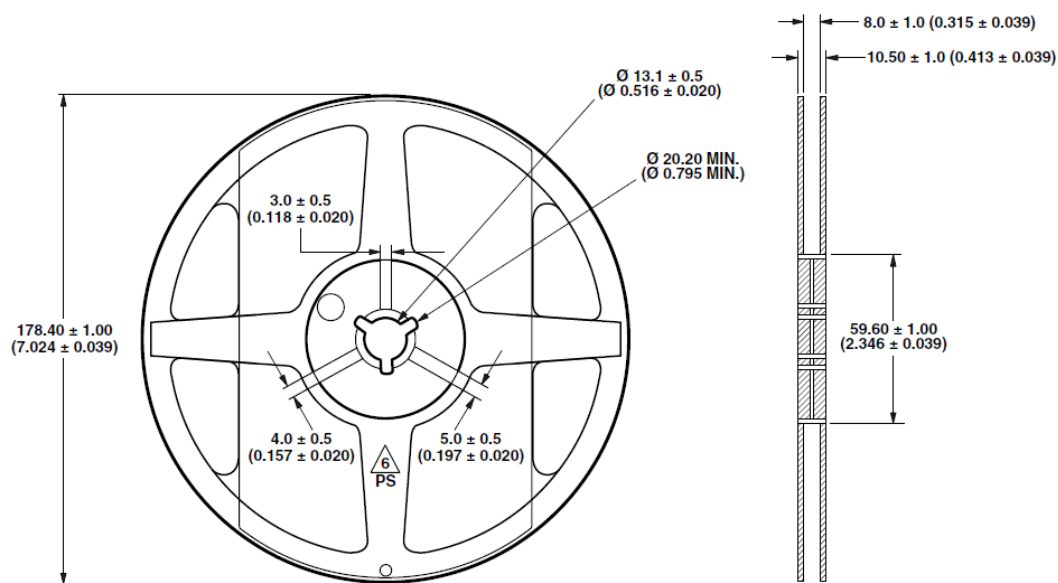
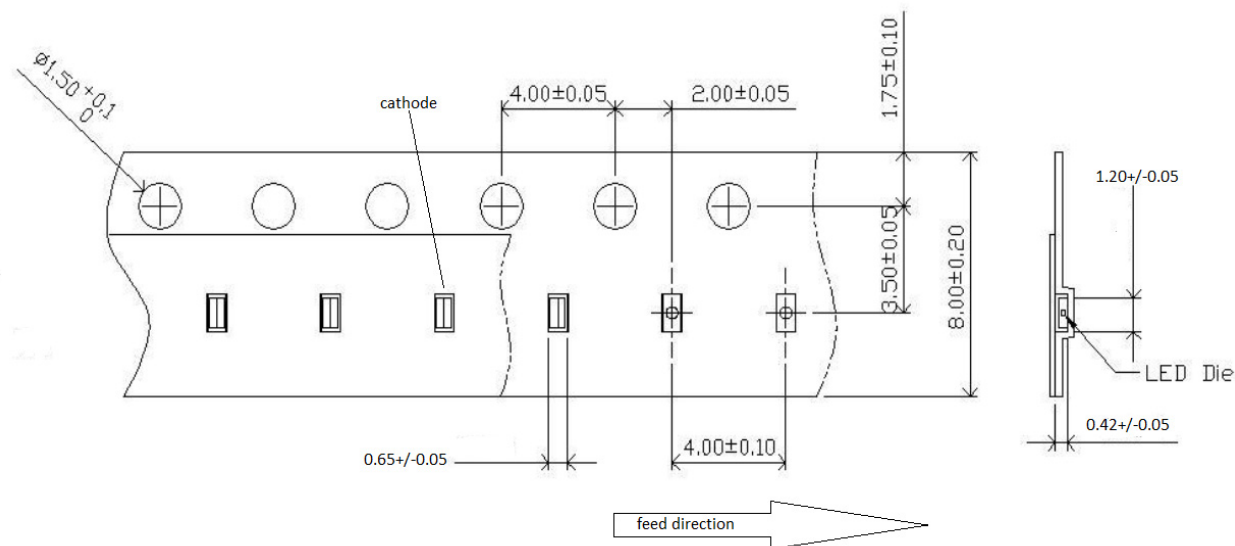


Figure 13: Reel Dimensions



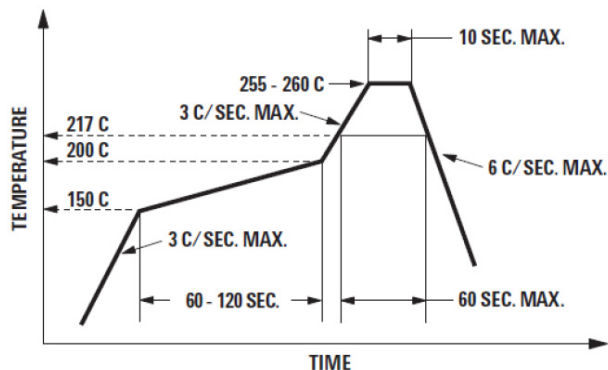
NOTE:
1. ALL DIMENSIONS IN MILLIMETERS (INCHES).

Figure 14: Carrier Tape Dimensions (Units: mm)



Soldering

Figure 15: Recommended Reflow Soldering Conditions



- Reflow soldering must not be done more than twice. Observe necessary precautions of handling moisture sensitive device as stated in the following section.
- Do not apply any pressure or force on the LED during reflow and after reflow when the LED is still hot.
- Use reflow soldering to solder the LED. If unavoidable (such as rework), use manual hand soldering strictly controlled to the following conditions:
 - Soldering iron tip temperature = 310°C maximum
 - Soldering duration = 2 seconds maximum
 - Number of cycles = 1 only
 - Power of soldering iron = 50W maximum
- Do not touch the LED package body with the soldering iron except for the soldering terminals because it might cause damage to the LED.
- Confirm beforehand whether the functionality and performance of the LED is affected by hand soldering.

Precautionary Notes

Handling of a Moisture-Sensitive Device

This product has a Moisture Sensitive Level 2a rating per JEDEC J-STD-020. Refer to Broadcom Application Note AN5305, *Handling of Moisture Sensitive Surface Mount Devices*, for additional details and a review of proper handling procedures.

■ Before use

- An unopened moisture barrier bag (MBB) can be stored at < 40°C/90% RH for 12 months. If the actual shelf life has exceeded 12 months and the humidity indicator card (HIC) indicates that baking is not required, it is safe to reflow the LEDs per the original MSL rating.
- Do not open the MBB prior to assembly (for example, for IQC).

■ Control after opening the MBB

- Read the HIC immediately upon opening the MBB.
- Keep the LEDs at < 30°C/60% RH at all times, and all high-temperature-related processes, including soldering, curing, or rework, must be completed within 672 hours.

■ Control for unfinished reel

Store unused LEDs in a sealed MBB with desiccant or desiccator at < 5% RH.

■ Control of assembled boards

If the PCB soldered with the LEDs is to be subjected to other high-temperature processes, store the PCB in a sealed MBB with desiccant or desiccator at < 5% RH to ensure that all LEDs have not exceeded their floor life of 672 hours.

■ Baking is required if the following conditions exist:

- The HIC indicator indicates a change in color for 10% and 5% as stated on the HIC.
- The LEDs are exposed to conditions of > 30°C/60% RH at any time.
- The LEDs' floor life exceeded 672 hours.

The recommended baking condition is: 60°C ±5°C for 20 hours.

Baking should only be done once.

Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperature as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.
- LEDs exhibit slightly different characteristics at different drive currents that might result in larger performance variations (that is, intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.
- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.
- Avoid rapid change in ambient temperature, especially in high humidity environments, because this will cause condensation on the LED.
- If the LED is intended to be used in harsh environments, protect the LED against damages caused by rain water, dust, oil, corrosive gases, external mechanical stress, and so on.

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